

RF Power MOSFET Transistor 10 W, 2 - 175 MHz, 28 V

Features

- N-Channel enhancement mode device
- DMOS structure
- Lower capacitances for broadband operation
- Common source configuration
- Low noise floor
- RoHS Compliant

ABSOLUTE MAXIMUM RATINGS AT 25° C

| Parameter | Symbol | Rating | Units |
|----------------------|----------------------|-------------|-------|
| Drain-Source Voltage | V _{DS} | 65 | V |
| Gate-Source Voltage | V _{GS} | 20 | V |
| Drain-Source Current | I _{DS} | 2.8 | А |
| Power Dissipation | PD | 35 | W |
| Junction Temperature | TJ | 200 | °C |
| Storage Temperature | T _{STG} | -65 to +150 | °C |
| Thermal Resistance | θ_{JC} | 2 | °C/W |

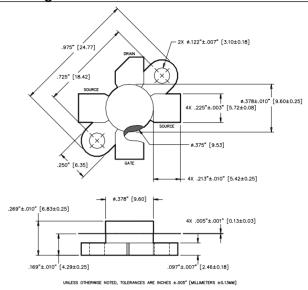
TYPICAL DEVICE IMPEDANCE

| F (MHz) | Z _{IN} (Ω) | Z _{LOAD} (Ω) | | |
|--|--------------------------|-----------------------|--|--|
| 30 | 20 - j11.0 | 23.0 + j3.0 | | |
| 50 | 24.0 - j15.0 19.0 +j5.0 | | | |
| 100 | 18.0 - j18.0 14.0 + j6.0 | | | |
| 200 | 12.0—j19.0 9.0 + j5.0 | | | |
| V _{DD} = 28V, I _{DQ} = 100mA, P _{OUT} = 10.0W | | | | |

 $Z_{\mbox{\scriptsize IN}}$ is the series equivalent input impedance of the device from gate to source.

 $Z_{\mbox{\scriptsize LOAD}}$ is the optimum series equivalent load impedance as measured from drain to ground.

Package Outline



| LETTER | MILLIMETERS | | INCHES | |
|--------|-------------|-------|--------|------|
| DIM | MIN | MAX | MIN | MAX |
| A | 24.64 | 24.89 | .970 | .980 |
| В | 18.29 | 18.54 | .720 | .730 |
| С | 20.07 | 20.83 | .790 | .820 |
| D | 9.47 | 9.73 | .373 | .383 |
| E | 6.22 | 6.48 | .245 | .255 |
| F | 5.64 | 5.79 | .222 | .228 |
| G | 2.92 | 3.30 | .115 | .130 |
| н | 2.29 | 2.67 | .090 | .105 |
| J | 4.04 | 4.55 | .159 | .179 |
| к | 6.58 | 7.39 | .259 | .291 |
| L | .10 | .15 | .004 | .006 |

ELECTRICAL CHARACTERISTICS AT 25°C

| Parameter | Symbol | Min | Max | Units | Test Conditions |
|--------------------------------|---------------------|-----|------|-------|--|
| Drain-Source Breakdown Voltage | BV _{DSS} | 65 | - | V | $V_{GS} = 0.0 \text{ V}$, $I_{DS} = 4.0 \text{ mA}$ |
| Drain-Source Leakage Current | I _{DSS} | - | 2.0 | mA | V_{GS} = 28.0 V , V_{GS} = 0.0 V |
| Gate-Source Leakage Current | I _{GSS} | - | 2.0 | μA | $V_{GS} = 20.0 \text{ V}$, $V_{DS} = 0.0 \text{ V}$ |
| Gate Threshold Voltage | V _{GS(TH)} | 2.0 | 6.0 | V | V _{DS} = 10.0 V , I _{DS} = 20 mA |
| Forward Transconductance | G _M | 160 | - | S | V_{DS} = 10.0 V , I_{DS} = 200 mA , Pulsed 80-300 μs |
| Input Capacitance | CISS | - | 14 | pF | V _{DS} = 28.0 V , F = 1.0 MHz |
| Output Capacitance | C _{OSS} | - | 10 | pF | V _{DS} = 28.0 V , F = 1.0 MHz |
| Reverse Capacitance | C _{RSS} | - | 4.6 | pF | V _{DS} = 28.0 V , F = 1.0 MHz |
| Power Gain | G _P | 13 | - | dB | V _{DD} = 28.0 V, I _{DQ} = 100 mA, P _{OUT} = 10 W F =175 MHz |
| Drain Efficiency | ŋ₀ | 55 | - | % | V_{DD} = 28.0 V, I_{DQ} = 100 mA, P_{OUT} = 10 W F =175 MHz |
| Load Mismatch Tolerance | VSWR-T | - | 20:1 | - | V_{DD} = 28.0 V, I_{DQ} = 100 mA, P_{OUT} = 10 W F =175 MHz |

1

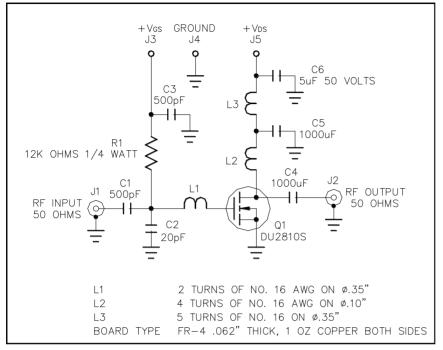
M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.

Rev. V1

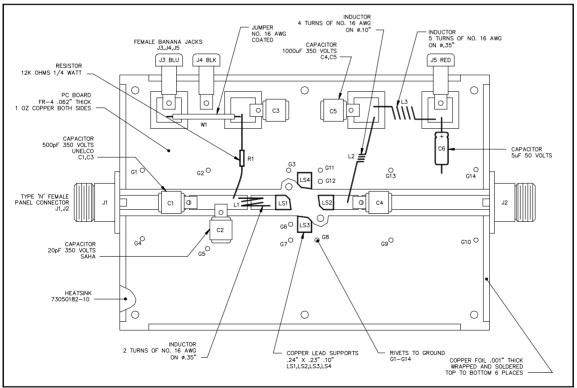
DU2810S

RF Power MOSFET Transistor 10 W, 2 - 175 MHz, 28 V

TEST FIXTURE SCHEMATIC



TEST FIXTURE ASSEMBLY



2

M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.



Rev. V1

DU2810S

RF Power MOSFET Transistor 10 W, 2 - 175 MHz, 28 V



Rev. V1

M/A-COM Technology Solutions Inc. All rights reserved.

Information in this document is provided in connection with M/A-COM Technology Solutions Inc ("MACOM") products. These materials are provided by MACOM as a service to its customers and may be used for informational purposes only. Except as provided in MACOM's Terms and Conditions of Sale for such products or in any separate agreement related to this document, MACOM assumes no liability whatsoever. MACOM assumes no responsibility for errors or omissions in these materials. MACOM may make changes to specifications and product descriptions at any time, without notice. MACOM makes no commitment to update the information and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to its specifications and product descriptions. No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document.

THESE MATERIALS ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, EITHER EXPRESS OR IMPLIED, RELATING TO SALE AND/OR USE OF MACOM PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, CONSEQUENTIAL OR INCIDENTAL DAMAGES, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. MACOM FURTHER DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. MACOM SHALL NOT BE LIABLE FOR ANY SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS, WHICH MAY RESULT FROM THE USE OF THESE MATERIALS.

MACOM products are not intended for use in medical, lifesaving or life sustaining applications. MACOM customers using or selling MACOM products for use in such applications do so at their own risk and agree to fully indemnify MACOM for any damages resulting from such improper use or sale.

³

M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit www.macom.com for additional data sheets and product information.